

N-Channel 100-V (D-S) MOSFET

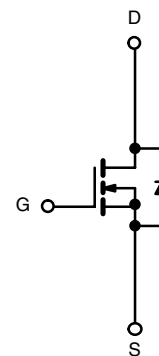
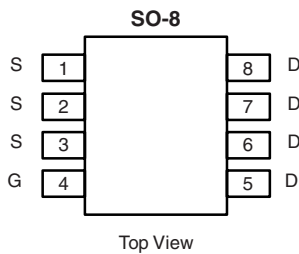
PRODUCT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
100	0.025 at V _{GS} = 10 V	7.9
	0.028 at V _{GS} = 6.0 V	7.5

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- 175 °C Maximum Junction Temperature
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE
Available



N-Channel MOSFET

Ordering Information: Si4486EY-T1-E3 (Lead (Pb)-free)
Si4486EY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage	V _{DS}	100		V	
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current (T _J = 175 °C) ^a	I _D	T _A = 25 °C	7.9	5.4	A
		T _A = 85 °C	6.1	4.2	
Pulsed Drain Current	I _{DM}	40			
Avalanche Current	I _{AR}	30		mJ	
Repetitive Avalanche Energy (Duty Cycle ≤ 1 %)	E _{AR}	45			
Continuous Source Current (Diode Conduction) ^a	I _S	3.1	1.5	A	
Maximum Power Dissipation ^a	P _D	T _A = 25 °C	3.8	1.8	W
		T _A = 85 °C	2.3	1.1	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R _{thJA}	t ≤ 10 s	33	40	°C/W
		Steady State	70	85	
Maximum Junction-to-Foot (Drain)	R _{thJF}	17	21		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

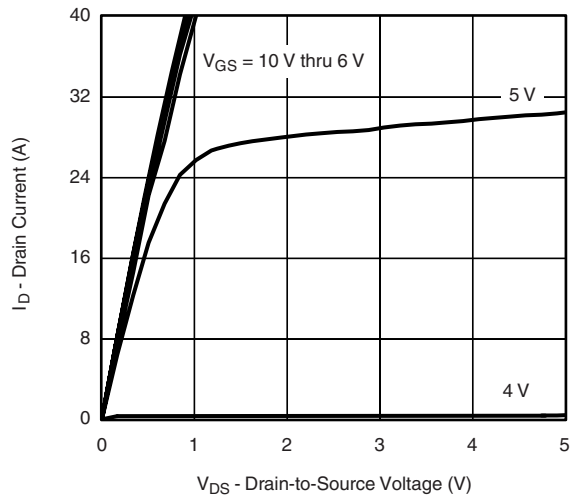
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 80\text{ V}, V_{GS} = 0\text{ V}$			1	μA
		$V_{DS} = 80\text{ V}, V_{GS} = 0\text{ V}, T_J = 85\text{ }^\circ\text{C}$			20	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 10\text{ V}$	40			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 7.9\text{ A}$		0.021	0.025	Ω
		$V_{GS} = 6.0\text{ V}, I_D = 7.5\text{ A}$		0.023	0.028	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 7.9\text{ A}$		35		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.1\text{ A}, V_{GS} = 0\text{ V}$		0.8	1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 50\text{ V}, V_{GS} = 10\text{ V}, I_D = 7.9\text{ A}$		36	44	nC
Gate-Source Charge	Q_{gs}			10		
Gate-Drain Charge	Q_{gd}			8.6		
Gate Resistance	R_g		0.5	1.27	2.2	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 50\text{ V}, R_L = 50\text{ }\Omega$ $I_D \cong 1\text{ A}, V_{GEN} = 10\text{ V}, R_g = 6\text{ }\Omega$		20	40	ns
Rise Time	t_r			10	20	
Turn-Off Delay Time	$t_{d(off)}$			46	90	
Fall Time	t_f			26	50	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 3.1\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		50	80	

Notes:

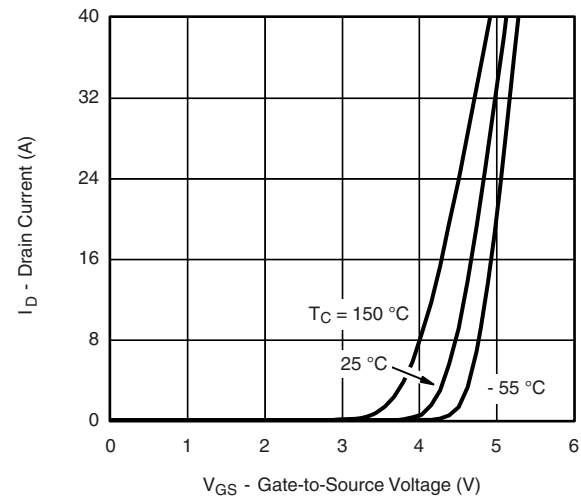
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $25\text{ }^\circ\text{C}$, unless otherwise noted

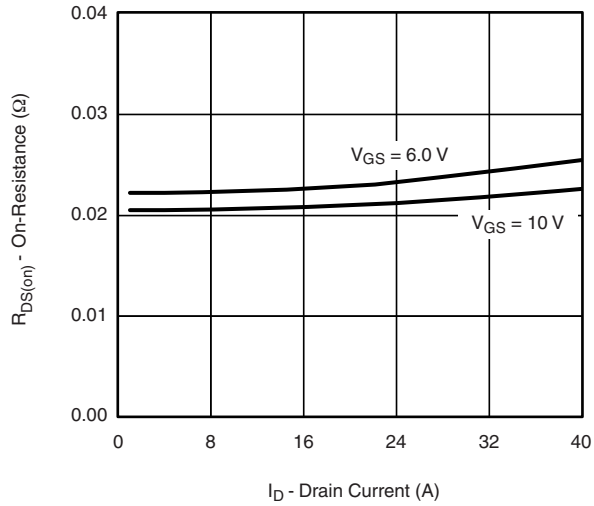


Output Characteristics

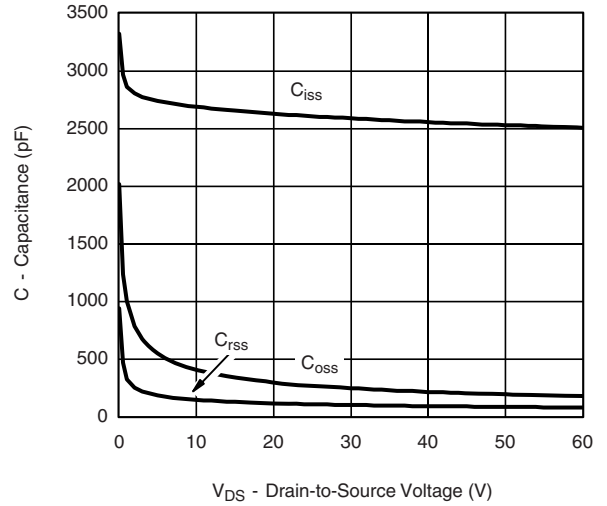


Transfer Characteristics

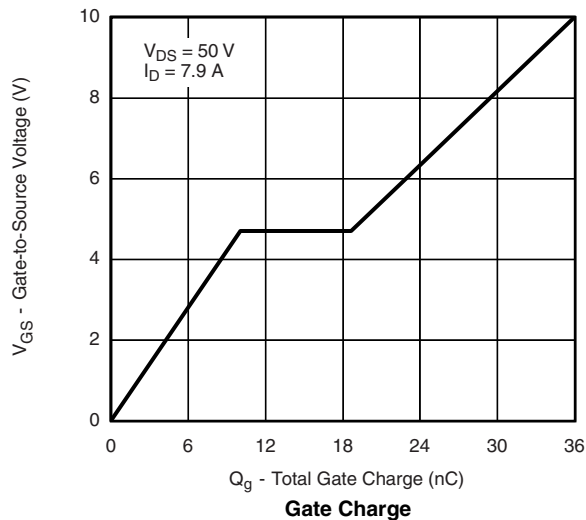
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



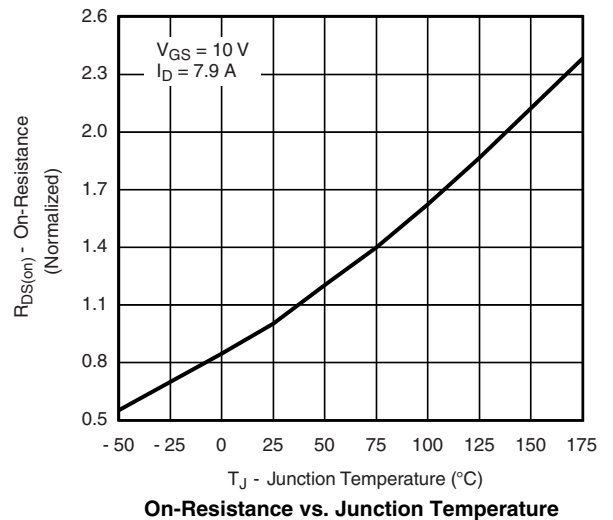
On-Resistance vs. Drain Current



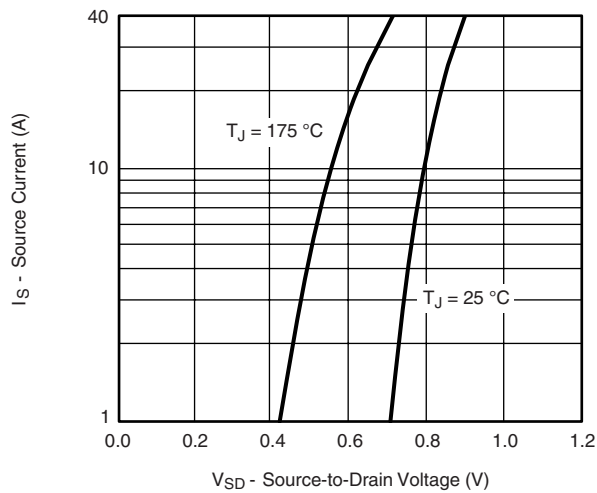
Capacitance



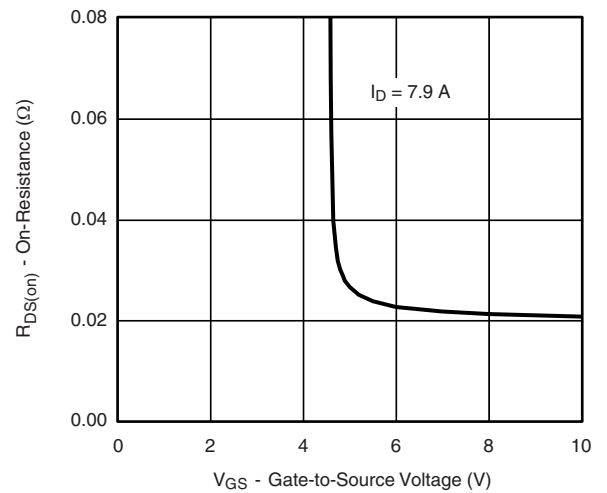
Gate Charge



On-Resistance vs. Junction Temperature

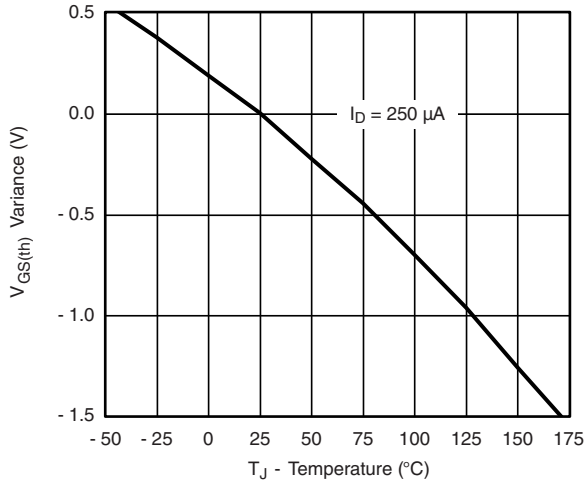


Source-Drain Diode Forward Voltage

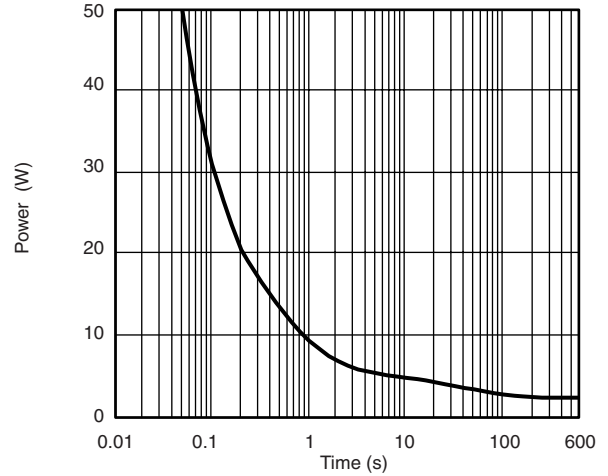


On-Resistance vs. Gate-to-Source Voltage

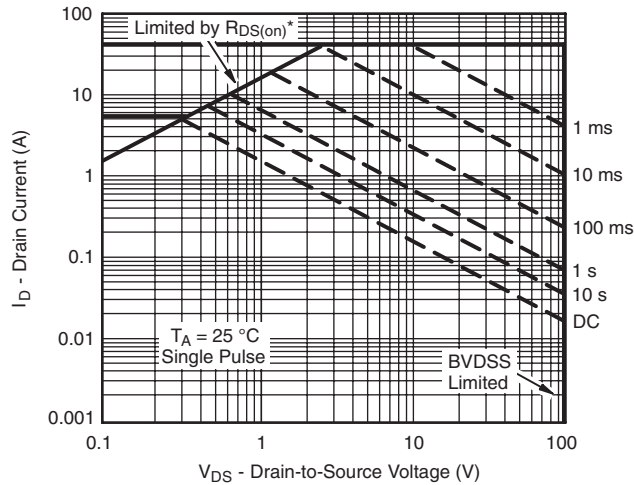
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Threshold Voltage

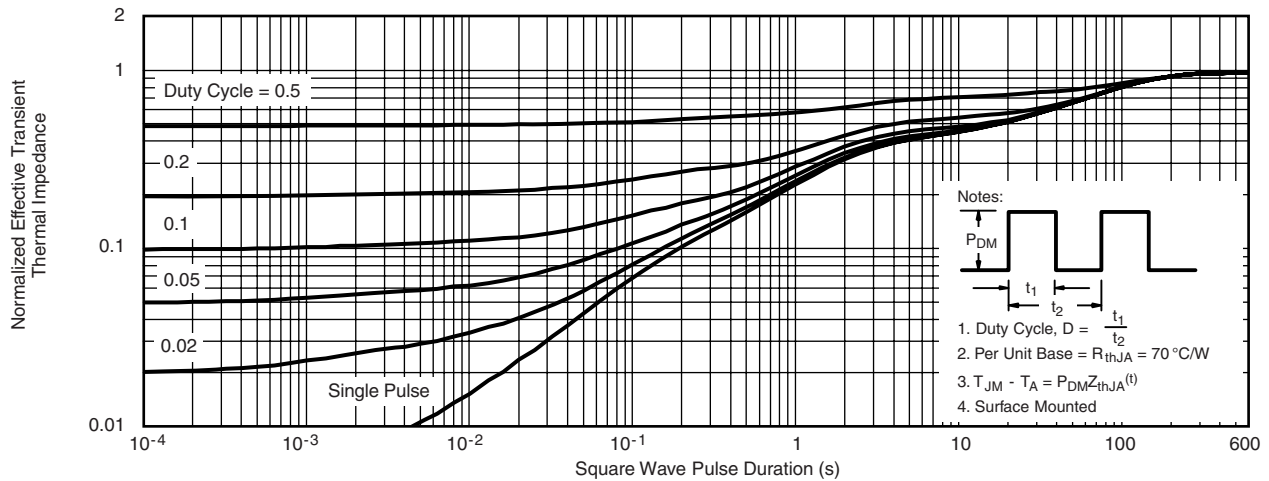


Single Pulse Power



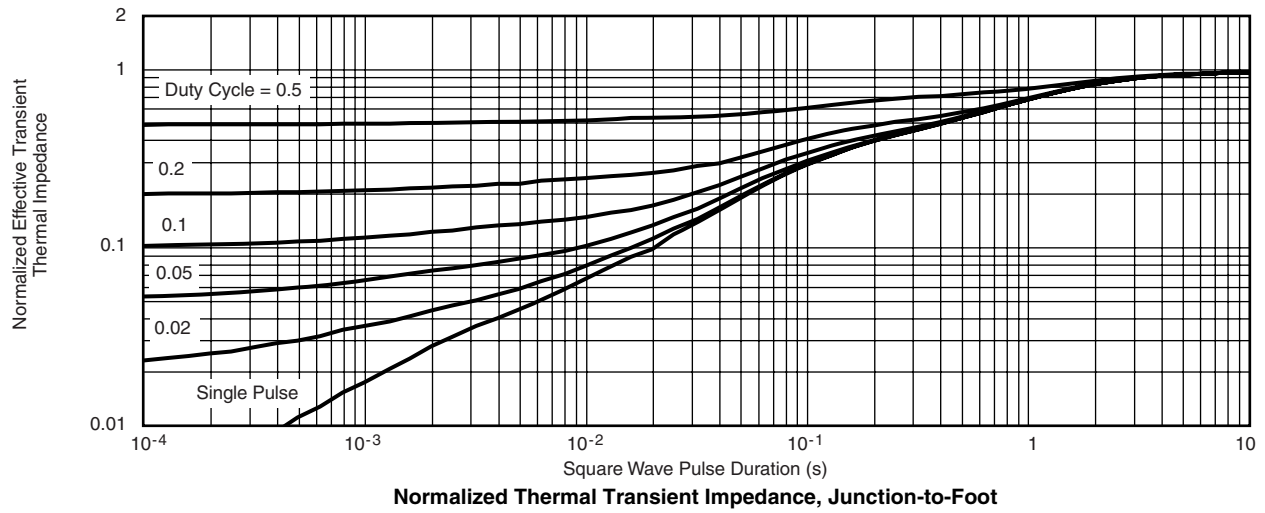
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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